

Title (en)

METHOD FOR CONNECTING A CURRENT SUPPLY WIRE WITH A CONTACT PATCH OF AN ELECTRICAL LAMP

Title (de)

VERFAHREN ZUM VERBINDEN EINES STROMZUFÜHRUNGSDRAHTES MIT EINEM KONTAKTBLECH EINER ELEKTRISCHEN LAMPE

Title (fr)

PROCEDE DESTINE A RELIER UN FIL D'ALIMENTATION DE COURANT A UNE PLAQUE DE CONTACT D'UNE LAMPE ELECTRIQUE

Publication

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Application

**EP 01909509 A 20010122**

Priority

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Abstract (en)

[origin: DE10003434A1] The invention relates to a method for connecting a contact patch (2) of a lamp socket, with a current supply wire (4), fed through an opening (2a) in said contact patch (2). The current supply wire (4) and the contact patch (2) are soldered together, by means of another wire (5) serving as a welding agent, whereby an arc is generated between the additional wire (5) and the current supply wire (4), or the contact patch (2). The solidified melt of the additional wire (5) closes the opening (2a) and forms a reliable soldered connection between the current supply wire (4) and the contact patch (2). The electrical voltage used to generate the arc, is preferably of a polarity such that the additional wire (5) is the anode and the current supply wire (4), or the contact patch (2) is the cathode. Said soldering process is best conducted under a protective atmosphere.

IPC 1-7

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IPC 8 full level

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